



MICRON_NOR QLLP LBGA SDP/DDP 11x13x1.4 64b (Auto) Assembly Site Addition of OSE Taiwan

PCN: 34881

Published: 2022-12-16

Type: Manufacturing Site - Change or Addition

Description: Micron is adding assembly site OSE Taiwan for QLLP LBGA SDP/DDP 11x13x1.4 64b products.

Site Locations:

Current :

(ATX SH) ATX Semiconductor Co,Ltd. China / Shanghai, No.669, Guoshoujing Road, Zhangjiang Hi-Tech Park, Pudong New Area, Shanghai 201203, P.R.C

Future:

(ATX SH) ATX Semiconductor Co,Ltd China / Shanghai, No.669, Guoshoujing Road, Zhangjiang Hi-Tech Park, Pudong New Area, Shanghai 201203, P.R.C

(OSE) - Semiconductor Group Manufacturing, No. 80, Jing 3rd Rd., Nanzih Dist., Kaohsiung 811, Taiwan (R.O.C.)

PKG	PACKAGE_TYPE	PACKAGE SIZE	QS Samples	Qual Report Avail	Product Ship Date
SDP	LBGA	11x13	2023-02-16	2023-02-28	2023-05-29
DDP	LBGA	11x13	2023-04-24	2023-05-08	2023-07-24

Reason: Supply Flexibility/Security

Product Affected: NOR QLLP LBGA SDP/DDP 11x13x1.4 64b

Affected Micron Part Number COMPONENT	Recommended Replacement	Customer Part Number
MT28FW01GABA1LPC-0AAT		
MT28FW02GBBA1HPC-0AAT		557-2026-ND
MT28FW02GBBA1LPC-0AAT		

*Materials that have been ordered are in **bold**.

Method of Identification: Master shipping container label will indicate country of origin from China to Taiwan.

Micron Sites Affected: Subcontractor

Sample Available: 2023-02-28

Qualification Reports Available: 2023-05-08

Product Ship Date: 2023-05-29

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NOTE: Per JEDEC Standard J-STD-046 Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change.

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Attachments

There are no attachments on this PCN